

东莞市科雅电子科技有限公司

規格承認書

SPECIFICATIONS FOR APPROVAL

客戶名稱:

CUSTOMER

立创商城

產品名稱:

ITEM

MKPDL205K3L2701

產品類型

CUSTOMER'S PART NO.

金属化聚丙烯盒式薄膜电容 (DPB) 直流支撑

產品規格

CUSTOMER'S P/N:

MKP-DL 205K1200V P27.5 32*24.5*15 KYET

日期

ISSUED DATE

2025/3/22

承認印 (APPROVAL STAMP)

供應商 (VENDER)

客戶 (CUSTOMER)



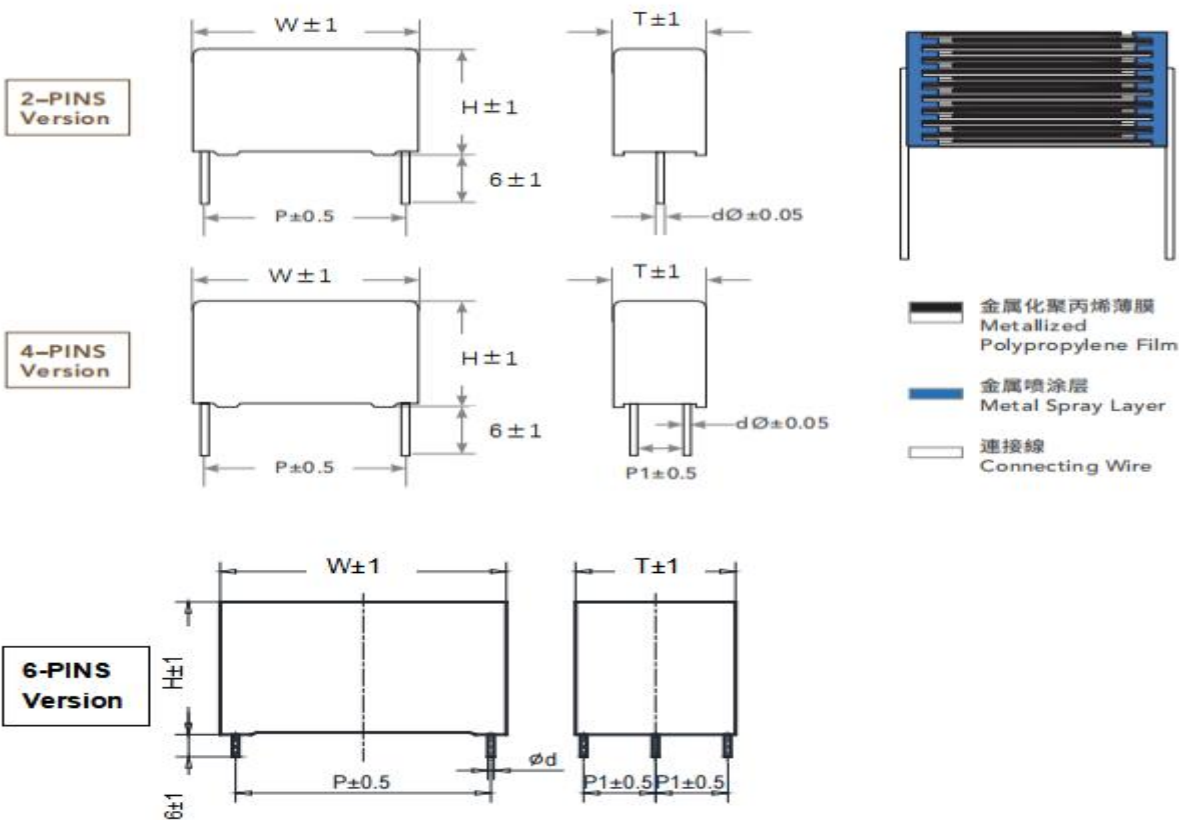
- ◆ 如果您有特殊要求请联系我们，我们将提供符合您要求的产品。
- ◆ If your requirement is special please contact us, we will test products as per your requirement.



版次	日期	变更内容
V1.0	2025/3/22	新产品承认书
正面激光印字		
KYET MKP-DL 2.0uF ± 10% 1200VDC 40/85/56 C3D		

东莞市科雅电子科技有限公司	发文部门：工程部	编号：KY-GCDPB
金属化聚丙烯膜电容(DPB)直流支撑 Metallized Polypropylene Film Capacitor-Radial (DPB) DC-Link	拟制：闰烺	制定日期： 2025/3/22
	审核：刘大鹏	版 本：V1.0

外形及结构图



结构 Construction:

电介质: 金属化聚丙烯薄膜
Dielectric: Metallized Polypropylene Film
绕卷: 低感式
Winding: Low inductive type
导线: 镀锡线
Leads: Tinned Wire
外层: 阻燃塑胶外壳, 环氧树脂填充
Outer Coating: Flame retarding plastic case and epoxy filled

特点 Feature:

高电容密度
High Capacitance Density
高纹波电流
High Ripple Current
良好的自愈性
Self-healing properties

推荐应用 Recommended Application:

高性能直流滤波应用 High performance DC filtering applications	太阳能逆变器 Solar inverters	变频器 Frequency converters
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电气特性 Electrical Characteristics:

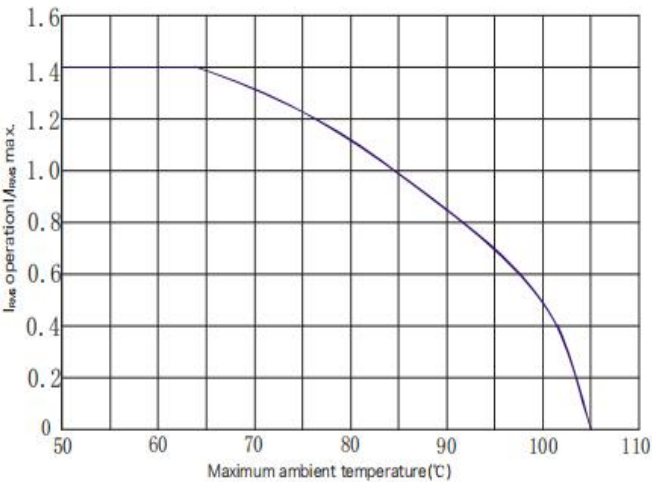
引用标准 Related Documents	IEC 61071/60068							
额定电压 Rated Voltage	V _{NDC} 85°C	500V	600V	800V	900V	1000V	1100V	1200V
	V _{OPDC} 70°C	600V	700V	900V	1000V	1100V	1200V	1300V
额定温度 Rated Temperature	-40°C ~+85°C							
最大运行温度(外壳) Maximum Operating Temperature (Case)	105°C							
容量范围 Capacitance Range	1.0uF~120uF							
容量误差 Capacitance Tolerance	±5% (J), ±10% (K)							
绝缘电阻 Insulation Resistance	Terminal to Terminal: (at 20°C ±5°C), Voltage charge time: 1 minute. Voltage: 100VDC IR*C≥10000S							
耐压 Withstand Voltage	Terminal to Terminal: (at 20°C ±5°C) 1.5 × VR applied for 10sec.							
自感 (Ls) Self inductance (Ls)	<1 nH per mm of lead spacing							
最大峰值电流 Î Maximum peak current Î(A)	Î = C.dv/dt							
注：若用于户外或长期湿度较大场合，建议选用防潮设计。								

V_{NDC} 85°C =1100VDC, V_{OPDC} 70°C = 1200VDC

Cap (uF)	Dimensions(mm)			P ±0.5	P1 ±0.5	d ±0.05	dV/dt (V/us)	Tanδ(%)		ESR 10KHz mΩ	I _{rms} 10KHz A	料号 Part Number
	W	H	T					1KHz	10KHz			
2.0	32	25	15	27.5	--	0.8	95	0.08	0.6	26.8	5.0	MKPDL205K3L2701

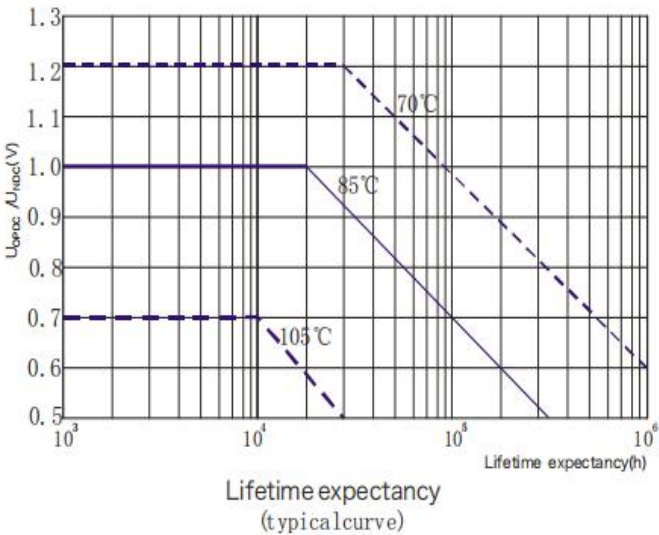
备注：产品外观颜色为黑色盒子黑色环氧树脂

预计寿命曲线



Maximum I_{RMS} current in function of the ambient temperature

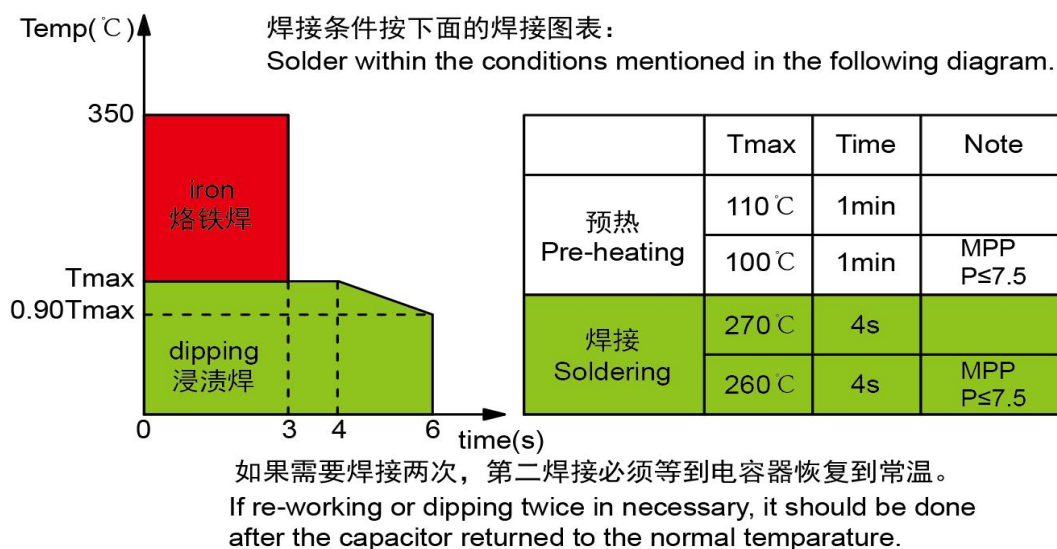
纹波电流降额曲线



可靠性试验要求：

项目	性能要求	试验方法
引出端强度 IEC 60068-2-21	外观无可见损伤	拉力试验：Ua1： 0.5 < $\phi d \leq 0.8\text{mm}$ ；10N 0.8 < $\phi d \leq 1.2\text{mm}$ ；20N
耐焊接热 IEC 60068-2-20	外观无可见损伤，标志清晰 Capacitanceat1 kHz Tan δ at10kHz $ \Delta C/C \leq 0.5\%$ Increaseoftan $\delta \leq 0.0050$	Solder bath Temperature at :260°C $\pm 5^\circ\text{C}$ Immersion time :10s $\pm 1\text{ s}$
耐久性 IEC 61071	Capacitanceat1 kHz Tan δ at10kHz $ \Delta C/C \leq 3.0\%$ Increase of tan $\delta \leq 150 \times 10^{-4} (10\text{KHz})$ IR $\geq$ 初始值*50%	1.3x UNDC atTmax. = 85°C Duration 500h 1000 $\times$ discharge at 1.4 $\times$ Ipeak(maximum Repetitive peakcurrent in continuous Operation) 1.3x UNDC atTmax. = 85°C Duration 500h
温度变化 IEC 60068-2-14	Capacitanceat1 kHz Tan δ at10kHz $ \Delta C/C \leq 2.0\%$ Increase of tan $\delta \leq 0.0150$ IR $\geq$ 初始值*50%	TestNb Tmax. = 85°C Tmin. = -40°C Transition time:1 h, equivalent to1 $^\circ\text{C}/\text{min}$
耐湿性 IEC 60068-2-78	Capacitanceat1 kHz Tan δ at10kHz $ \Delta C/C \leq 2\%$ Increase of tan $\delta \leq 150 \times 10^{-4} (10\text{KHz})$ IR $\geq$ 初始值*50%	Tmax. = 40°C $\pm 2^\circ\text{C}$ RH = 93% $\pm 3\%$ Duration : 56 days
耐湿负荷 AEC-Q200	Capacitanceat1 kHz Tan δ at10kHz $ \Delta C/C \leq 5.0\%$ Increase of tan $\delta \leq 150 \times 10^{-4} (10\text{KHz})$ IR $\geq$ 初始值*50%	Tmax. = 60°C $\pm 2^\circ\text{C}$ RH = 93% $\pm 3\%$ at U _{NDC} Duration : 1000h
自愈性测试 IEC 61071	Capacitanceat1 kHz Tan δ at10kHz $ \Delta C/C \leq 0.5\%$ tan $\delta \leq 1.2 \times \text{initialtan}\delta + 0.0001$	1.5x UNDC Duration10s Numberofclearings ≤ 5 Increase the voltage at100V/still 5, witha max. of 2.5x U _{NDC} fora duration of 10s
放电试验 IEC 61071	Capacitanceat1 kHz Tan δ at10kHz $ \Delta C/C \leq 1.0\%$ Increase of tan $\delta \leq 0.0150$ IR $\geq$ 初始值*50%	1.1x U _{NDC} Number of discharges: 5 Time lapse: every 2 min (10mintotal)

焊接温度要求

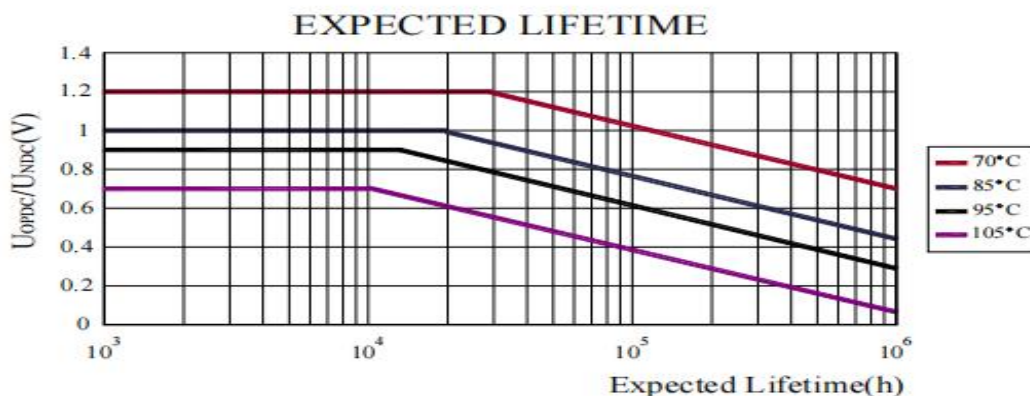


a.手工焊接时，MPP 薄膜电容器是全部元件里面耐温最差的元件，请特别注意焊接时间，尽量不要超过 5 秒，焊点尽量离本体远一些，另外不适合回流焊焊接，否则产品会因薄膜热收缩导致性能问题；

b.波峰焊锡时，电容不宜卧式安装，直插 PC 板为宜,防止焊锡时，锡波烫伤电容器内部材料; 焊锡载具建议不要加盖，尽量降低电容过锡炉的温度；预热三段温度 80-100°C之间，温度 260°C+/-5；（温度越低越安全）焊锡时间 5S 内完成；（双波峰焊总时间）焊锡过程不得有停顿/卡料，导致焊锡成品板受热时间和焊锡时间变长,造成烫伤潜在隐患；（其他焊锡方式，都需遵循此要求）

c.金属化薄膜电容器环境温度在 $\geq 85^{\circ}\text{C}$ 时，远离高热元件，防止其他元件热量影响电容器正常工作。

电容工作温度与额定电压降低比例

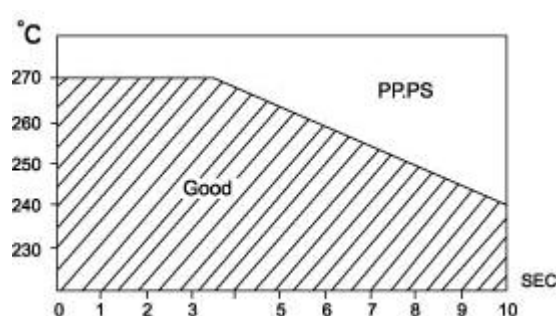
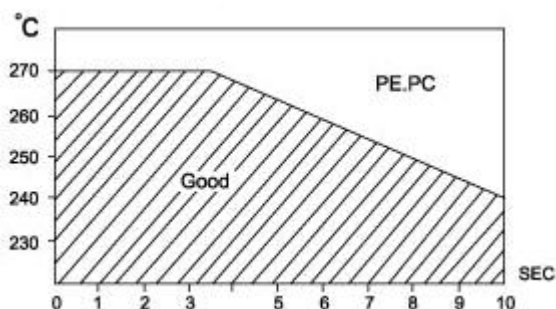


The temperatures-curves are the case-temperatures measured at the hottest point of the capacitor has reached its thermal equilibrium.

薄膜电容性能参数 Electrical Characteristics of Film Capacitor

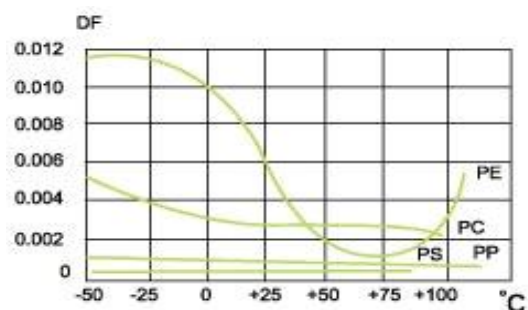
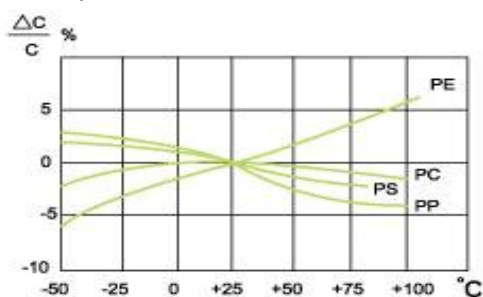
1. 焊接温度与时间对比

Soldering Temperature VS Time



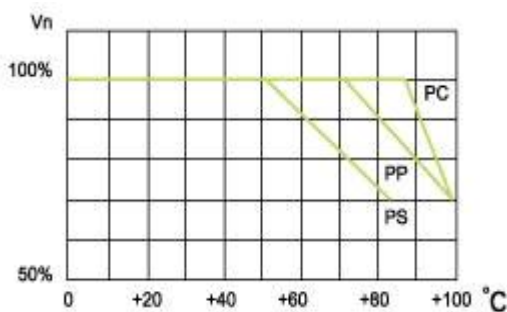
2. 温度性能

Temperature Characteristic



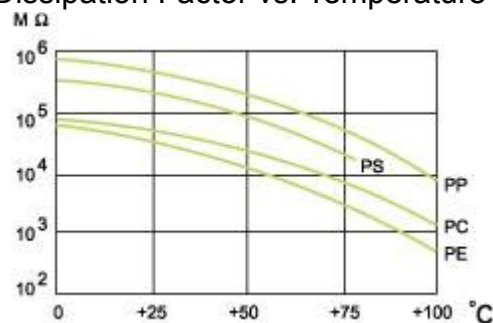
容量变化率与温度的关系

Capacitance vs. Temperature



损耗角正切与温度的关系

Dissipation Factor vs. Temperature

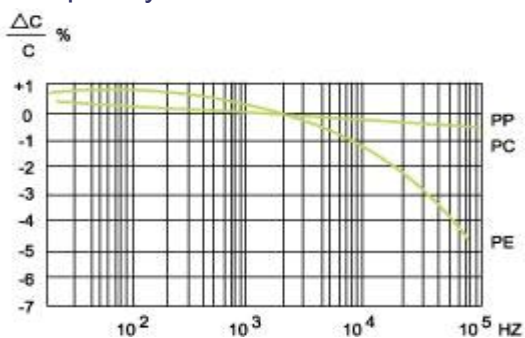


使用电压与温度的关系

Operation voltage vs. Temperature

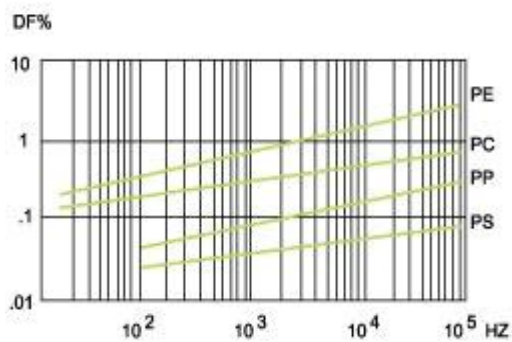
3. 频率性能

Frequency Characteristics



容量变化率与频率的关系

Capacitance vs. Frequency



损耗角正切与频率的关系

Dissipation Factor vs. Frequency